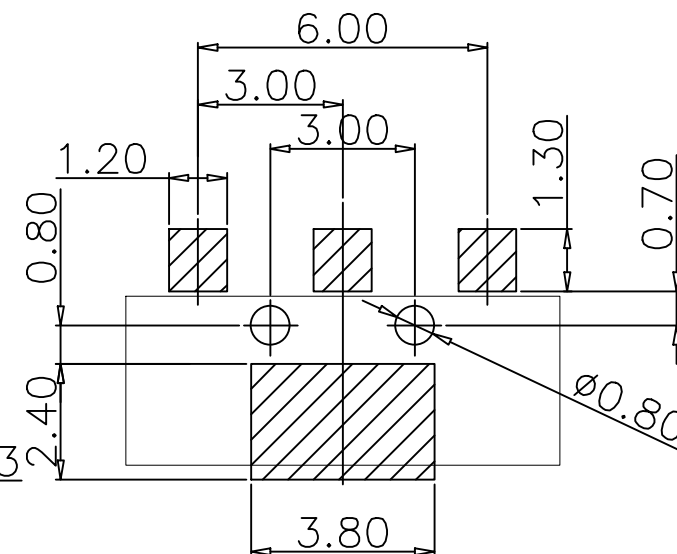
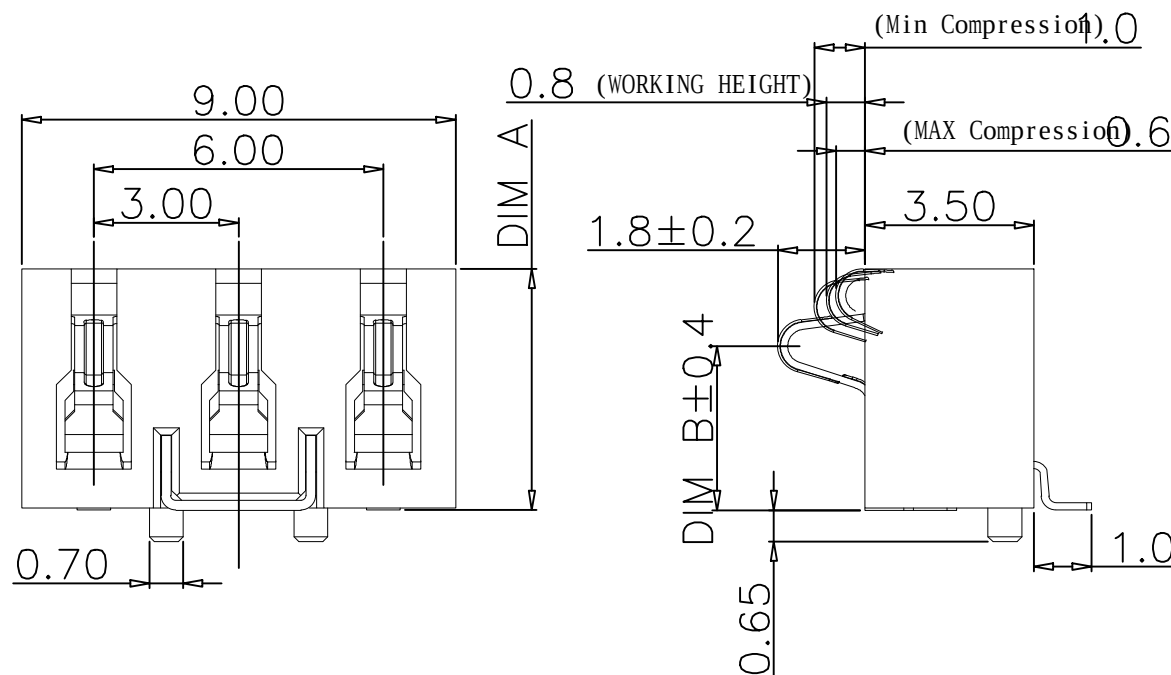


REV.	ECN.NO.	MODIFY.CONTENT	DATE
A		NEW	2011/10/31



RECOMMENDED PCB LAYOUT
TOL:(±0.05)

Note:

1.Material:

1.1 Housing: High temperature thermoplastic UL94v-0

1.2 Contact: Phosphor Bronze

1.3 Nail: Stainless steel

2.Finish:

2.1 CONTACT: G/F" Gold plated on contact area;

G/F plated on solder tails, Base Nickel :50u"Min

2.2 Nail: 50u" NICKEL UNDER,100u" TIN OVERALL

3.Specification:

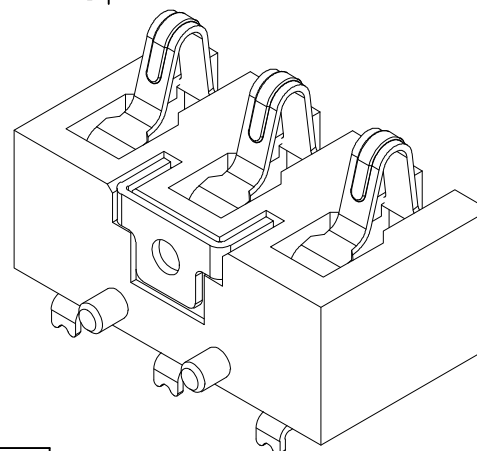
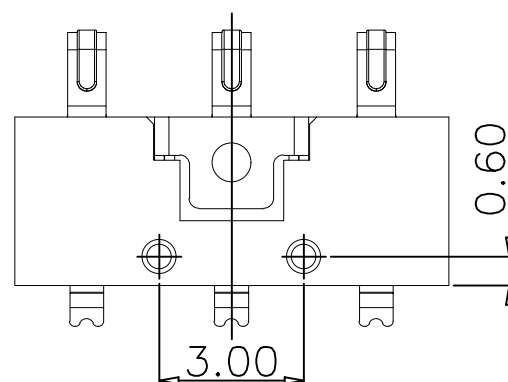
3.1 Current rating: 2.5 A Max.

3.2 Dielectric withstanding voltage: 500 V(ac) r.m.s.

3.3 Contact resistance: 30mΩ Max.

3.4 Insulation resistance: 500MΩ Min.

3.5 Operating Temperature: -55°C~85°C



規格	DIM A	DIM B
B C S 3 - D 5 6 S	7.2	5.6
B C S 3 - D 5 2 S	6.8	5.2
B C S 3 - D 4 4 S	6.0	4.4
B C S 3 - D 3 8 S	5.4	3.8
B C S 3 - D 3 4 S	5.0	3.4
B C S 3 - D 3 0 S	4.6	3.0

GENERAL TOLERANCE		DWG NO.	BCS3-DXXS	APPD:	WIND	Scale	1:1
X.±0.45	x.*±5'	Title	3PH Battery Conn.	CHKD:		UNIT	mm
.X±0.35	.x.*±2'			DR:			
.XX±0.25	.xx.*±1'	Part NO.	SEE TABLE	Date	2012/02/29		
.XXX±0.15	.xxx.*±0.5'						
SHEET	1/3						